

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing pursuant to 37 C.F.R. §1.53 is the patent application of:

INVENTORS:

Hatsuo ISHIDA
2903 Weybridge Road
Shaker Heights, Ohio 44120-1873

Koichi SHIBAYAMA
2-1 Hyakuyama Shimamoto-chou
Osaka 618-8589 JAPAN

Hiroshi ABE
c/o Sekisui Integrated Research, Inc.
3-5-24 Miyahara, Yodogawa-ku
Osaka 532-0003 JAPAN

FOR: A THERMOSETTING RESIN COMPOSITION AND ITS ARTICLE

Enclosed are:

- ☐ () sheets of drawings.
- ☐ An Assignment of the invention to: Sekisui Chemical Co., Ltd.
- ☐ An associate power of attorney.
- ☒ A Notice of Informal Filing of New Patent Application.
- ☒ A Japanese language Specification, Claims and Abstract.

The filing fee is calculated as follows:

| | CLAIMS AS | FILED | SMALL ENTITY | | OTHER THAN A SMALL ENTITY |
|--------------|------------|-----------|-----------------|----|------------------------------|
| FOR | NO. FILED | NO. EXTRA | RATE FEE | | RATE FEE |
| BASIC FEE | | | \$375 | | \$ 770 |
| Total Claims | 16-20= | -0- | x9= | or | x18= -0- |
| Indep claims | 8-3= | -5- | X43= -0- | or | x86= \$ 430 |
| [] Multiple | Dep claims | | +145= -0- | or | +290= -0- |
| | | | TOTAL | | TOTAL \$1200 |

X Check in the amount of \$ 1200.00 is enclosed.

The Commissioner is hereby authorized to charge \$ to Deposit Account No. 20-1424 for the filing fee listed above.

The Commissioner is hereby authorized to charge \$ to the credit card identified in the attached Credit Card Payment Form for the filing fee listed above.

X The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

- x Any additional fees under 37 CFR 1.16 for the presentation of extra claims.
- x Any patent application processing fees under 37 CFR 1.17.

X The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

- x Any patent application processing fees under 37 CFR 1.17, including extension of time fees.
- x Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Respectfully submitted,

Donald E. Townsend, Jr.

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Reg. No. 43,198

Donald E. Townsend

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Reg. No. 22,069

Date: March 30, 2004

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
H. Ishida, et al.

Serial No.: To Be Assigned

Art Unit: To Be Assigned

Filed: Concurrently Herewith

Examiner: To Be Assigned

For: A Thermosetting Resin Composition And Its Article

INFORMAL FILING OF NEW PATENT APPLICATION


Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

BOX PATENT APPLICATIONS

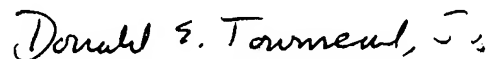
Sir:

The undersigned has been authorized by the Applicants, Hatsuo Ishida, Koichi Shibayama, and Hiroshi Abe, to file the enclosed patent application, and to defer filing of the Declaration/Power of Attorney.

Respectfully submitted,



Donald E. Townsend
Reg. No. 22,069



Donald E. Townsend, Jr.
Reg. No. 43,198

Date: March 30, 2004

Docket No.: FUJ-002-USA-P

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